504908656 05/10/2018

PATENT ASSIGNMENT COVER SHEET

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SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT

CONVEYING PARTY DATA

Name	Execution Date
MICHAEL A. STUBER	07/07/2014

RECEIVING PARTY DATA

Name:	SILANNA SEMICONDUCTOR U.S.A., INC.	
Street Address:	4350 EXECUTIVE DRIVE	
Internal Address:	SUITE 200	
City:	SAN DIEGO	
State/Country:	CALIFORNIA	
Postal Code:	92121	

PROPERTY NUMBERS Total: 1

Property Type	Number
Application Number:	15154477

CORRESPONDENCE DATA

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Correspondence will be sent to the e-mail address first; if that is unsuccessful, it will be sent

using a fax number, if provided; if that is unsuccessful, it will be sent via US Mail.

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Email: marcella.thompson@haynesboone.com
Correspondent Name: HAYNES AND BOONE, LLP (36340)

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Address Line 2: 2323 VICTORY AVENUE, SUITE 700

Address Line 4: DALLAS, TEXAS 75219

ATTORNEY DOCKET NUMBER:	36340.349US06	
NAME OF SUBMITTER:	MARCELLA THOMPSON	
SIGNATURE:	/Marcella Thompson/	
DATE SIGNED:	05/10/2018	

Total Attachments: 2

source=160556C1B2D1 Assignment - Inventors to Silanna#page1.tif source=160556C1B2D1 Assignment - Inventors to Silanna#page2.tif

PATENT 504908656 REEL: 045767 FRAME: 0506

Attorney Docket No.: IOSEP015C1

ASSIGNMENT

For good and valuable consideration, We, Michael A. Stuber, residing in Carlsbad, CA, Stuart B. Molin, residing in Carlsbad, CA, and Chris Brindle, residing in Poway. CA:

Hereby sell, assign and transfer to SILANNA SEMICONDUCTOR U.S.A., INC., having a principal place of business at 4350 Executive Drive, Suite 200, San Diego, CA 92121, hereinafter "Assignee", its successors, assigns and legal representatives, the entire right, title and interest in and for the United States and all foreign countries, in and to any and all improvements which are disclosed in the application for a United States Patent 14/272,261 filed on May 7, 2014 and entitled:

Semiconductor-on-insulator integrated circuit with interconnect below the insulator

and in and to said application and all divisional, continuing, substitute, renewal, reissue, and all other applications for Letters Patent which have been or shall be filed in the United States and all foreign countries on any of said improvements; and in and to all original and reissued patents which have been or shall be filed in the United States and all foreign countries on said improvements;

Agree that said Assignee may apply for and receive Letters Patent for said improvements in its own name; and that, when requested, without charge to but at the expense of said Assignee, its successors, assigns and legal representatives, to carry out in good faith the intent and purpose of this assignment, the undersigned will execute all divisional, continuing, substitute, renewal, reissue, and all other patent applications on any and all said improvements; execute all rightful oaths, assignments, powers of attorney and other papers; communicate to said Assignee, its successors, assigns, and legal representatives, all facts known to the undersigned relating to said improvements and the history thereof, and generally do everything possible which said Assignee, its successors, assigns or legal representatives shall consider desirable for aiding in securing and maintaining proper patent protection for said improvements and for vesting title to said improvements and all applications for patents and all patents on said improvements, in said Assignee, its successors, assigns and legal representatives; and

Covenant with said Assignee, its successors, assigns and legal representatives that no assignment, grant, mortgage, license or other agreement affecting the rights and property herein conveyed has been made to others by the undersigned, and that full right to convey the same as herein expressed is possessed by the undersigned.

Michael A. Stuber Date Witness Date

Witness

Page 1 of 2

Attorney Docket No.: IOSEP015C1

Stuart B. Molin

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